

**STFM1000XXNAEB2X**  
 (Not Recommended for New Designs)  
 CONNECTIVITY - FM TUNER

**Package**  
 HVQFN32  
 HVQFN32, plastic, thermal enhanced very thin quad flatpack; no leads; 32 terminals; 0.5 mm pitch; 5 mm x 5 mm x 1 mm body



Image not available

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## Buy Options

STFM1000XXNAEB2X  
 935312331557  
 NOT RECOMMENDED FOR NEW DESIGNS

TRAY-Tray, Bakeable, Multiple in Drypack  
 Min. Package Quantity: 490  
 Lead Time: 15 weeks

## Operating Characteristics

No information available

## Environmental Information

Material Declaration	PbFree	EU RoHS	Halogen Free	RHF Indicator	2nd Level Interconnect	REACH SVHC	Weight (mg)
<a href="#">STFM1000XXNAEB2X</a> (935312331557)	Yes	Yes <a href="#">Certificate Of Analysis (CoA)</a>	Yes	D	e3	<a href="#">REACH SVHC</a>	62.4

## Quality Information

Material Declaration	Safe Assure Functional Safety	Moisture Sensitivity Level (MSL)	Peak Package Body Temperature (PPT) (C°)	Maximum Time at Peak Temperatures (s)
		Lead Free Soldering	Lead Free Soldering	Lead Free Soldering
<a href="#">STFM1000XXNAEB2X</a> (935312331557)	No	3	260	40

## Shipping Information

Part Number	Harmonized Tariff (US) <a href="#">Disclaimer</a>	Export Control Classification Number (US)
<a href="#">STFM1000XXNAEB2X</a> (935312331557)	854231	5A992

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